

## **Document Title**

1M x 16 bits Dynamic RAM with EDO Page Mode

## **Revision History**

| Revision No | <u>History</u>              | <u>Draft Date</u> | <u>Remark</u> |
|-------------|-----------------------------|-------------------|---------------|
| 0A          | Initial Draft               | June 5,2001       |               |
| 0B          | Revise for typographic      | November 9,2001   |               |
| 0C          | Add Pb-free package         | May 06,2004       |               |
| 0D          | Change tcoн from 5ns to 4ns | November 26,2004  |               |
|             |                             |                   |               |

The attached datasheets are provided by ICSI. Integrated Circuit Solution Inc reserve the right to change the specifications and products. ICSI will answer to your questions about device. If you have any questions, please contact the ICSI offices.



# 1M x 16 (16-MBIT) DYNAMIC RAM WITH EDO PAGE MODE

#### **FEATURES**

- · Extended Data-Out (EDO) Page Mode access cycle
- TTL compatible inputs and outputs; tristate I/O
- · Refresh Interval:

Refresh Mode: 1,024 cycles /16 ms
RAS-Only, CAS-before-RAS (CBR), and Hidden
Self refresh Mode - 1,024 cycles / 128ms

- · JEDEC standard pinout
- Single power supply: 5V ± 10% (IC41C16100S) 3.3V ± 10% (IC41LV16100S)
- Byte Write and Byte Read operation via two CAS
- Industrail Temperature Range -40°C to 85°C

#### DESCRIPTION

The *ICSI* IC41C16100S and IC41LV16100S are 1,048,576 x 16-bit high-performance CMOS Dynamic Random Access Memories. These devices offer an accelerated cycle access called EDO Page Mode. EDO Page Mode allows 1,024 random accesses within a single row with access cycle time as short as 20 ns per 16-bit word. The Byte Write control, of upper and lower byte, makes the IC41C16100S ideal for use in 16-, 32-bit wide data bus systems.

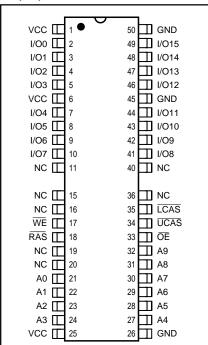
These features make the IC41C16100Sand IC41LV16100S ideally suited for high-bandwidth graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IC41C16100S and IC41LV16100S are packaged in a 42-pin 400mil SOJ and 400mil 50- (44-) pin TSOP-2.

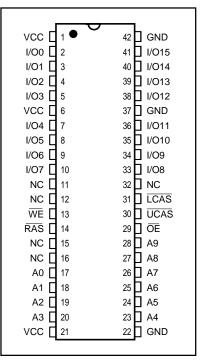
#### **KEY TIMING PARAMETERS**

| Parameter                             | -45 | -50 | -60 | Unit |  |
|---------------------------------------|-----|-----|-----|------|--|
| Max. RAS Access Time (trac)           | 45  | 50  | 60  | ns   |  |
| Max. CAS Access Time (tcac)           | 11  | 13  | 15  | ns   |  |
| Max. Column Address Access Time (taa) | 22  | 25  | 30  | ns   |  |
| Min. EDO Page Mode Cycle Time (tpc)   | 16  | 20  | 25  | ns   |  |
| Min. Read/Write Cycle Time (tRc)      | 77  | 84  | 104 | ns   |  |

# PIN CONFIGURATIONS 50(44)-Pin TSOP II



### 42-Pin SOJ



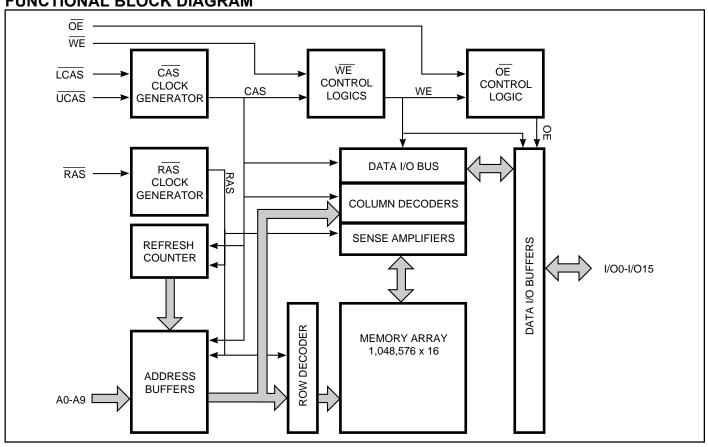
#### PIN DESCRIPTIONS

| A0-A9       | Address Inputs              |
|-------------|-----------------------------|
| I/O0-15     | Data Inputs/Outputs         |
| WE          | Write Enable                |
| ŌĒ          | Output Enable               |
| RAS         | Row Address Strobe          |
| <u>UCAS</u> | Upper Column Address Strobe |
| LCAS        | Lower Column Address Strobe |
| Vcc         | Power                       |
| GND         | Ground                      |
| NC          | No Connection               |
|             |                             |

ICSI reserves the right to make changes to its products at any time without notice in order to improve design and supply the best possible product. We assume no responsibility for any errors which may appear in this publication. © Copyright 2000, Integrated Circuit Solution Inc.



# **FUNCTIONAL BLOCK DIAGRAM**



# IC41C16100S IC41LV16100S



### **TRUTH TABLE**

| Function                          |                       | RAS               | LCAS              | UCAS              | WE                | ŌĒ                | Address tr/tc | I/O                                    |
|-----------------------------------|-----------------------|-------------------|-------------------|-------------------|-------------------|-------------------|---------------|--|
| Standby                           |                       | Н                 | Н                 | Н                 | Х                 | Х                 | Χ             | High-Z                                 |
| Read: Word                        |                       | L                 | L                 | L                 | Н                 | L                 | ROW/COL       | Douт                                   |
| Read: Lower Byte                  |                       | L                 | L                 | Н                 | Н                 | L                 | ROW/COL       | Lower Byte, Dout<br>Upper Byte, High-Z |
| Read: Upper Byte                  |                       | L                 | Н                 | L                 | Н                 | L                 | ROW/COL       | Lower Byte, High-Z<br>Upper Byte, Dout |
| Write: Word (Early Write)         |                       | L                 | L                 | L                 | L                 | Χ                 | ROW/COL       | Din                                    |
| Write: Lower Byte (Early V        | Vrite)                | L                 | L                 | Н                 | L                 | Х                 | ROW/COL       | Lower Byte, DIN<br>Upper Byte, High-Z  |
| Write: Upper Byte (Early V        | Vrite)                | L                 | Н                 | L                 | L                 | Х                 | ROW/COL       | Lower Byte, High-Z<br>Upper Byte, DIN  |
| Read-Write <sup>(1,2)</sup>       |                       | L                 | L                 | L                 | H→L               | L→H               | ROW/COL       | Dout, Din                              |
| EDO Page-Mode Read <sup>(2)</sup> | 1st Cycle:            | L                 | H→L               | H→L               | Н                 | L                 | ROW/COL       | Douт                                   |
|                                   | 2nd Cycle:            | L                 | $H{ ightarrow} L$ | $H{ ightarrow} L$ | Н                 | L                 | NA/COL        | Dout                                   |
|                                   | Any Cycle:            | L                 | $L{\rightarrow}H$ | $L{\rightarrow}H$ | Н                 | L                 | NA/NA         | Douт                                   |
| EDO Page-Mode Write(1)            | 1st Cycle:            | L                 | $H{ ightarrow} L$ | $H{ ightarrow} L$ | L                 | Χ                 | ROW/COL       | Din                                    |
|                                   | 2nd Cycle:            | L                 | $H{ ightarrow} L$ | $H{ ightarrow} L$ | L                 | Χ                 | NA/COL        | DIN                                    |
| EDO Page-Mode <sup>(1,2)</sup>    | 1st Cycle:            | L                 | H→L               | H→L               | H→L               | L→H               | ROW/COL       | Dout, Din                              |
| Read-Write                        | 2nd Cycle:            | L                 | $H{ ightarrow} L$ | $H{ ightarrow} L$ | $H{ ightarrow} L$ | $L{\rightarrow}H$ | NA/COL        | Dout, Din                              |
| Hidden Refresh                    | Read <sup>(2)</sup> L | .→H→L             | L                 | L                 | Н                 | L                 | ROW/COL       | Douт                                   |
|                                   | Write(1,3) L          | .→H→L             | L                 | L                 | L                 | Χ                 | ROW/COL       | Dout                                   |
| RAS-Only Refresh                  |                       | L                 | Н                 | Н                 | Х                 | Х                 | ROW/NA        | High-Z                                 |
| CBR Refresh <sup>(4)</sup>        |                       | $H{ ightarrow} L$ | L                 | L                 | Χ                 | Χ                 | Χ             | High-Z                                 |

- These WRITE cycles may also be BYTE WRITE cycles (either LCAS or UCAS active).
   These READ cycles may also be BYTE READ cycles (either LCAS or UCAS active).
- 3. EARLY WRITE only.
- 4. At least one of the two CAS signals must be active (LCAS or UCAS).



## **Functional Description**

The IC41C16100S and IC41LV16100S is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 16 address bits. These are entered ten bits (A0-A9) at a time. The row address is latched by the Row Address Strobe (RAS). The column address is latched by the Column Address Strobe (CAS). RAS is used to latch the first ten bits and CAS is used the latter ten bits.

The IC41C16100S and IC41LV16100S has two CAS controls, ICAS and UCAS. The ICAS and UCAS inputs internally generates a CAS signal functioning in an identical manner to the single CAS input on the other 1M x 16 DRAMs. The key difference is that each CAS controls its corresponding I/O tristate logic (in conjunction with OE and WE and RAS). ICAS controls I/O0 through I/O7 and UCAS controls I/O8 through I/O15.

#### **Memory Cycle**

A memory cycle is initiated by bring RAS LOW and it is terminated by returning both RAS and CAS HIGH. To ensures proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum tras time has expired. A new cycle must not be initiated until the minimum precharge time trap, top has elapsed.

#### Read Cycle

A read cycle is initiated by the falling edge of  $\overline{CAS}$  or  $\overline{OE}$ , whichever occurs last, while holding  $\overline{WE}$  HIGH. The column address must be held for a minimum time specified by tar. Data Out becomes valid only when trac, taa, toac and toea are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

#### Write Cycle

A write cycle is initiated by the falling edge of  $\overline{CAS}$  and  $\overline{WE}$ , whichever occurs last. The input data must be valid at or before the falling edge of  $\overline{CAS}$  or  $\overline{WE}$ , whichever occurs first.

## Refresh Cycle

To retain data, 1,024 refresh cycles are required in each 16 ms period. There are two ways to refresh the memory.

- By clocking each of the 1,024 row addresses (A0 through A9) with RAS at least once every 16 ms. Any read, write, read-modify-write or RAS-only cycle refreshes the addressed row.
- Using a CAS-before-RAS refresh cycle. CAS-before-RAS refresh is activated by the falling edge of RAS, while holding CAS LOW. In CAS-before-RAS refresh cycle, an internal 10-bit counter provides the row

addresses and the external address inputs are ignored.

CAS-before-RAS is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

## Self Refresh Cycle

The Self Refresh allows the user a dynamic refresh, data retention mode at the extended refresh period of 128 ms. i.e., 125  $\mu$ s per row when using distributed CBR refreshes. The feature also allows the user the choice of a fully static, low power data retention mode. The optional Self Refresh feature is initiated by performing a CBR Refresh cycle and holding  $\overline{RAS}$  LOW for the specified trans.

The Self Refresh mode is terminated by driving RAS HIGH for a minimum time of transport that completion of any internal refresh cycles that may be in process at the time of the RAS LOW-to-HIGH transition. If the DRAM controller uses a distributed refresh sequence, a burst refresh is not required upon exiting Self Refresh.

However, if the DRAM controller utilizes a RAS-only or burst refresh sequence, all 1,024 rows must be refreshed within the average internal refresh rate, prior to the resumption of normal operation.

#### **Extended Data Out Page Mode**

EDO page mode operation permits all 1,024 columns within a selected row to be randomly accessed at a high data rate.

In EDO page mode read cycle, the data-out is held to the next  $\overline{\text{CAS}}$  cycle's falling edge, instead of the rising edge. For this reason, the valid data output time in EDO page mode is extended compared with the fast page mode. In the fast page mode, the valid data output time becomes shorter as the  $\overline{\text{CAS}}$  cycle time becomes shorter. Therefore, in EDO page mode, the timing margin in read cycle is larger than that of the fast page mode even if the  $\overline{\text{CAS}}$  cycle time becomes shorter.

In EDO page mode, due to the extended data function, the CAS cycle time can be shorter than in the fast page mode if the timing margin is the same.

The EDO page mode allows both read and write operations during one  $\overline{RAS}$  cycle, but the performance is equivalent to that of the fast page mode in that case.

#### Power-On

After application of the Vcc supply, an initial pause of 200 µs is required followed by a minimum of eight initialization cycles (any combination of cycles containing a RAS signal).

During power-on, it is recommended that  $\overline{RAS}$  track with Vcc or be held at a valid ViH to avoid current surges.



### ABSOLUTE MAXIMUM RATINGS(1)

| Symbol | Parameters                         |      | Rating       | Unit |
|--------|------------------------------------|------|--------------|------|
| VT     | Voltage on Any Pin Relative to GND | 5V   | -1.0 to +7.0 | V    |
|        |                                    | 3.3V | -0.5 to +4.6 |      |
| Vcc    | Supply Voltage                     | 5V   | -1.0 to +7.0 | V    |
|        |                                    | 3.3V | -0.5 to +4.6 |      |
| Іоит   | Output Current                     |      | 50           | mA   |
| PD     | Power Dissipation                  |      | 1            | W    |
| TA     | Commercial Operation Temperature   |      | 0 to +70     | °C   |
|        | Industrial Operationg Temperature  |      | -40 to +85   | °C   |
| Tstg   | Storage Temperature                |      | -55 to +125  | °C   |

#### Note:

# **RECOMMENDED OPERATING CONDITIONS** (Voltages are referenced to GND.)

| Symbol | Parameter                      |      | Min. | Тур. | Max.      | Unit |
|--------|--------------------------------|------|------|------|-----------|------|
| Vcc    | Supply Voltage                 | 5V   | 4.5  | 5.0  | 5.5       | V    |
|        |                                | 3.3V | 3.0  | 3.3  | 3.6       |      |
| VIH    | Input High Voltage             | 5V   | 2.4  | _    | Vcc + 1.0 | V    |
|        |                                | 3.3V | 2.0  | _    | Vcc + 0.3 |      |
| VIL    | Input Low Voltage              | 5V   | -1.0 | _    | 0.8       | V    |
|        |                                | 3.3V | -0.3 | _    | 8.0       |      |
| TA     | Commercial Ambient Temperature |      | 0    | _    | 70        | °C   |
|        | Industrial Ambient Temperature |      | -40  | _    | 85        | °C   |

# CAPACITANCE(1,2)

| Symbol | Parameter                                  | Max. | Unit |
|--------|--|------|------|
| CIN1   | Input Capacitance: A0-A9                   | 5    | pF   |
| CIN2   | Input Capacitance: RAS, UCAS, LCAS, WE, OE | 7    | pF   |
| Сю     | Data Input/Output Capacitance: I/O0-I/O15  | 7    | pF   |

- 1. Tested initially and after any design or process changes that may affect these parameters.
- 2. Test conditions: T<sub>A</sub> = 25°C, f = 1 MHz.

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



## **ELECTRICAL CHARACTERISTICS(1)**

(Recommended Operating Conditions unless otherwise noted.)

| Symbol | Parameter                    | Test Condition   | Speed | Min.       | Max. | Unit |
|--------|------------------------------|--|-------|------------|------|------|
| lı∟    | Input Leakage Current        | Any input 0V ≤ V <sub>IN</sub> ≤ Vcc<br>Other inputs not under test = 0V |       | <b>–</b> 5 | 5    | μA   |
| lio    | Output Leakage Current       | Output is disabled (Hi-Z)<br>0V ≤ Vouт ≤ Vcc                             |       | <b>–</b> 5 | 5    | μA   |
| Vон    | Output High Voltage Level    | Iон = -5.0 mA (5V)<br>Iон = -2.0 mA (3.3V)                               |       | 2.4        | _    | V    |
| Vol    | Output Low Voltage Level     | IoL = 4.2 mA (5V)<br>IoL = 2.0 mA (3.3V)                                 |       | _          | 0.4  | V    |
| Icc1   | Standby Current: TTL         | RAS, LCAS, UCAS ≥ VIH Commerical   | 5V    | _          | 2    | mA   |
|        | ,                            | , ,  | 3.3V  | _          | 1    |      |
|        |                              | Extended   | 5V    | _          | 3    | mΑ   |
|        |                              |  | 3.3V  | _          | 2    |      |
| Icc2   | Standby Current: CMOS        | RAS, LCAS, UCAS ≥ Vcc – 0.2V   | 5V    | _          | 1    | mA   |
|        | •                            |  | 3.3V  | _          | 0.5  |      |
| Icc3   | Operating Current:           | RAS, LCAS, UCAS,   | -45   | _          | 190  | mA   |
|        | Random Read/Write(2,3,4)     | Address Cycling, trc = trc (min.)  | -50   |            | 160  |      |
|        | Average Power Supply Current |  | -60   | _          | 145  |      |
| Icc4   | Operating Current:           | RAS = VIL, LCAS, UCAS,   | -45   | _          | 100  | mA   |
|        | EDO Page Mode(2,3,4)         | Cycling tpc = tpc (min.)   | -50   | _          | 90   |      |
|        | Average Power Supply Current |  | -60   | _          | 80   |      |
| Icc5   | Refresh Current:             | RAS Cycling, LCAS, UCAS ≥ VIH  | -45   | _          | 180  | mA   |
|        | RAS-Only <sup>(2,3)</sup>    | trc = trc (min.)   | -50   | _          | 160  |      |
|        | Average Power Supply Current |  | -60   | _          | 145  |      |
| Icc6   | Refresh Current:             | RAS, LCAS, UCAS Cycling  | -45   | _          | 180  | mA   |
|        | CBR <sup>(2,3,5)</sup>       | trc = trc (min.)   | -50   | _          | 160  |      |
|        | Average Power Supply Current |  | -60   | _          | 145  |      |
| Iccs   | Self Refresh Current         | Self Refresh mode  | _     | _          | 300  | μA   |

<sup>1.</sup> An initial pause of 200  $\mu s$  is required after power-up followed by eight  $\overline{RAS}$  refresh cycles ( $\overline{RAS}$ -Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tree refresh requirement is exceeded.

<sup>2.</sup> Dependent on cycle rates.

<sup>3.</sup> Specified values are obtained with minimum cycle time and the output open.

<sup>4.</sup> Column-address is changed once each EDO page cycle.5. Enables on-chip refresh and address counters.



# **AC CHARACTERISTICS**(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

|               |  | -    | 45   | -    | 50   | -60  |      |       |
|---------------|--|------|------|------|------|------|------|-------|
| Symbol        | Parameter  | Min. | Max. | Min. | Max. | Min. | Max. | Units |
| trc           | Random READ or WRITE Cycle Time                        | 77   | _    | 84   | _    | 104  | _    | ns    |
| <b>t</b> rac  | Access Time from RAS(6, 7)                             | _    | 45   | _    | 50   | _    | 60   | ns    |
| tcac          | Access Time from $\overline{CAS}^{(6,8,15)}$           | _    | 11   | _    | 13   | _    | 15   | ns    |
| <b>t</b> AA   | Access Time from Column-Address <sup>(6)</sup>         | _    | 22   | _    | 25   | _    | 30   | ns    |
| <b>t</b> ras  | RAS Pulse Width  | 45   | 10K  | 50   | 10K  | 60   | 10K  | ns    |
| <b>t</b> RP   | RAS Precharge Time                                     | 28   | _    | 30   | _    | 40   | _    | ns    |
| tcas          | CAS Pulse Width(26)                                    | 7    | 10K  | 8    | 10K  | 10   | 10K  | ns    |
| <b>t</b> CP   | CAS Precharge Time(9, 25)                              | 7    | _    | 9    | _    | 9    |      | ns    |
| <b>t</b> csH  | CAS Hold Time (21)                                     | 35   | _    | 38   | _    | 40   | _    | ns    |
| trcd          | RAS to CAS Delay Time(10, 20)                          | 10   | 34   | 12   | 37   | 14   | 45   | ns    |
| <b>t</b> asr  | Row-Address Setup Time                                 | 0    | _    | 0    | _    | 0    |      | ns    |
| <b>t</b> rah  | Row-Address Hold Time                                  | 6    | _    | 8    | _    | 10   |      | ns    |
| tasc          | Column-Address Setup Time(20)                          | 0    | _    | 0    | _    | 0    |      | ns    |
| <b>t</b> CAH  | Column-Address Hold Time(20)                           | 6    | _    | 8    | _    | 10   |      | ns    |
| <b>t</b> ar   | Column-Address Hold Time (referenced to RAS)           | 30   | _    | 30   | _    | 40   | _    | ns    |
| <b>t</b> RAD  | RAS to Column-Address Delay Time(11)                   | 8    | 23   | 10   | 25   | 12   | 30   | ns    |
| <b>t</b> ral  | Column-Address to RAS Lead Time                        | 23   | _    | 25   | _    | 30   |      | ns    |
| <b>t</b> RPC  | RAS to CAS Precharge Time                              | 5    | _    | 5    | _    | 5    | _    | ns    |
| <b>t</b> RSH  | RAS Hold Time(27)                                      | 6    | _    | 8    | _    | 10   |      | ns    |
| <b>t</b> RHCP | RAS Hold Time from CAS Precharge                       | 37   | _    | 37   | _    | 37   |      | ns    |
| tclz          | CAS to Output in Low-Z <sup>(15, 29)</sup>             | 0    | _    | 0    | _    | 0    | _    | ns    |
| tcrp          | CAS to RAS Precharge Time(21)                          | 5    | _    | 5    | _    | 5    |      | ns    |
| top           | Output Disable Time(19, 28, 29)                        | 3    | 13   | 3    | 15   | 3    | 15   | ns    |
| toe           | Output Enable Time(15, 16)                             | _    | 11   | _    | 13   | _    | 15   | ns    |
| toed          | Output Enable Data Delay (Write)                       | 20   | _    | 20   | _    | 20   |      | ns    |
| toehc         | OE HIGH Hold Time from CAS HIGH                        | 5    | _    | 5    | _    | 5    |      | ns    |
| <b>t</b> oep  | OE HIGH Pulse Width                                    | 10   | _    | 10   | _    | 10   | _    | ns    |
| toes          | OE LOW to CAS HIGH Setup Time                          | 5    | _    | 5    | _    | 5    |      | ns    |
| trcs          | Read Command Setup Time(17, 20)                        | 0    | _    | 0    | _    | 0    | _    | ns    |
| <b>t</b> RRH  | Read Command Hold Time (referenced to RAS)(12)         | 0    | _    | 0    | _    | 0    | _    | ns    |
| <b>t</b> RCH  | Read Command Hold Time (referenced to CAS)(12, 17, 21) | 0    | _    | 0    | _    | 0    | _    | ns    |
| twcн          | Write Command Hold Time(17, 27)                        | 6    | _    | 8    |      | 10   |      | ns    |
| twcr          | Write Command Hold Time                                | 40   | _    | 40   | _    | 50   | _    | ns    |
|               | (referenced to RAS)(17)                                |      |      |      |      |      |      |       |
| twp           | Write Command Pulse Width <sup>(17)</sup>              | 6    |      | 8    |      | 10   |      | ns    |
| <b>t</b> wpz  | WE Pulse Widths to Disable Outputs                     | 10   |      | 10   | _    | 10   | _    | ns    |
| trwl          | Write Command to RAS Lead Time(17)                     | 11   |      | 13   |      | 15   |      | ns    |
| tcwL          | Write Command to CAS Lead Time(17, 21)                 | 6    |      | 8    |      | 10   |      | ns    |
| twcs          | Write Command Setup Time(14, 17, 20)                   | 0    |      | 0    |      | 0    |      | ns    |
| <b>t</b> DHR  | Data-in Hold Time (referenced to RAS)                  | 39   |      | 39   |      | 39   |      | ns    |



# AC CHARACTERISTICS (Continued)(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

|               |   | -4   | -45  |      | 50   | -(   | 60   |       |
|---------------|---|------|------|------|------|------|------|-------|
| Symbol        | Parameter   | Min. | Max. | Min. | Max. | Min. | Max. | Units |
| tach          | Column-Address Setup Time to CAS Precharge during WRITE Cycle       | 15   | _    | 15   | _    | 15   | _    | ns    |
| tоен          | OE Hold Time from WE during READ-MODIFY-WRITE cycle <sup>(18)</sup> | 6    | _    | 8    | _    | 10   | _    | ns    |
| tos           | Data-In Setup Time(15, 22)  | 0    | _    | 0    | _    | 0    | _    | ns    |
| <b>t</b> DH   | Data-In Hold Time <sup>(15, 22)</sup>                               | 6    | _    | 8    | _    | 10   | _    | ns    |
| trwc          | READ-MODIFY-WRITE Cycle Time  | 95   | _    | 108  | _    | 133  | _    | ns    |
| <b>t</b> RWD  | RAS to WE Delay Time during READ-MODIFY-WRITE Cycle <sup>(14)</sup> | 55   | _    | 64   | _    | 77   | _    | ns    |
| tcwd          | CAS to WE Delay Time(14, 20)  | 21   | _    | 26   | _    | 32   | _    | ns    |
| tawd          | Column-Address to WE Delay Time(14)                                 | 32   | _    | 39   | _    | 47   | _    | ns    |
| <b>t</b> PC   | EDO Page Mode READ or WRITE<br>Cycle Time <sup>(24)</sup>           | 16   | _    | 20   | _    | 25   | _    | ns    |
| <b>t</b> RASP | RAS Pulse Width in EDO Page Mode                                    | 45   | 100K | 50   | 100K | 60   | 100K | ns    |
| <b>t</b> CPA  | Access Time from CAS Precharge(15)                                  | _    | 27   |      | 30   |      | 35   | ns    |
| <b>t</b> PRWC | EDO Page Mode READ-WRITE<br>Cycle Time <sup>(24)</sup>              | 51   | _    | 56   | _    | 68   | _    | ns    |
| tсон          | Data Output Hold after CAS LOW                                      | 4    | _    | 4    | _    | 4    | _    | ns    |
| toff          | Output Buffer Turn-Off Delay from CAS or RAS(13,15,19,29)           | 1.6  | 11   | 1.6  | 12   | 1.6  | 15   | ns    |
| twnz          | Output Disable Delay from WE  | 3    | 10   | 3    | 10   | 3    | 10   | ns    |
| <b>t</b> CLCH | Last CAS going LOW to First CAS returning HIGH <sup>(23)</sup>      | 8    | _    | 10   |      | 10   | _    | ns    |
| tcsr          | CAS Setup Time (CBR REFRESH)(30, 20)                                | 5    | _    | 5    | _    | 5    | _    | ns    |
| tchr          | CAS Hold Time (CBR REFRESH)(30, 21)                                 | 8    | _    | 8    | _    | 10   | _    | ns    |
| tord          | OE Setup Time prior to RAS during HIDDEN REFRESH Cycle              | 0    | _    | 0    | _    | 0    | _    | ns    |
| tref          | Auto Refresh Period (1,024 Cycles)                                  | _    | 16   | _    | 16   | _    | 16   | ms    |
| tref          | Self Refresh Period (1,024 Cycles)                                  | _    | 128  | _    | 128  | _    | 128  | ms    |
| tτ            | Transition Time (Rise or Fall)(2, 3)                                | 1    | 50   | 1    | 50   | 1    | 50   | ns    |

### **AC TEST CONDITIONS**

Output load: Two TTL Loads and 50 pF (Vcc =  $5.0V \pm 10\%$ )
One TTL Load and 50 pF (Vcc =  $3.3V \pm 10\%$ )

Input timing reference levels:  $V_{IH} = 2.4V$ ,  $V_{IL} = 0.8V$  ( $V_{CC} = 5.0V \pm 10\%$ );  $V_{IH} = 2.0V$ ,  $V_{IL} = 0.8V$  ( $V_{CC} = 3.3V \pm 10\%$ )

Output timing reference levels:  $V_{OH} = 2.0V$ ,  $V_{OL} = 0.8V$  ( $V_{CC} = 5V \pm 10\%$ ,  $3.3V \pm 10\%$ )

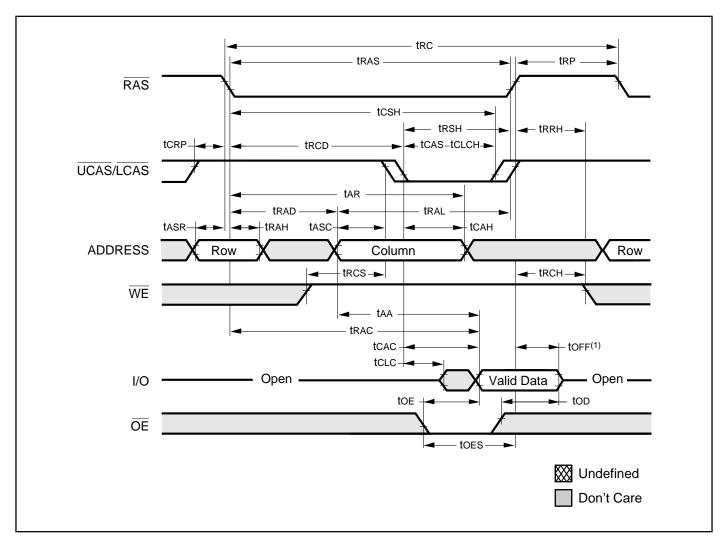
# IC41C16100S IC41LV16100S



- 1. An initial pause of 200 μs is required after power-up followed by eight RAS refresh cycle (RAS-Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tree refresh requirement is exceeded.
- 2. V<sub>IH</sub> (MIN) and V<sub>IL</sub> (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between V<sub>IH</sub> and V<sub>IL</sub> (or between V<sub>IL</sub> and V<sub>IH</sub>) and assume to be 1 ns for all inputs.
- 3. In addition to meeting the transition rate specification, all input signals must transit between V<sub>I</sub>H and V<sub>I</sub>L (or between V<sub>I</sub>L and V<sub>I</sub>H) in a monotonic manner.
- 4. If  $\overline{CAS}$  and  $\overline{RAS}$  = V<sub>IH</sub>, data output is High-Z.
- 5. If  $\overline{CAS} = V_{IL}$ , data output may contain data from the last valid READ cycle.
- 6. Measured with a load equivalent to one TTL gate and 50 pF.
- 7. Assumes that tRCD ≤ tRCD (MAX). If tRCD is greater than the maximum recommended value shown in this table, tRAC will increase by the amount that tRCD exceeds the value shown.
- 8. Assumes that tRCD ≥ tRCD (MAX).
- 9. If  $\overline{\text{CAS}}$  is LOW at the falling edge of  $\overline{\text{RAS}}$ , data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer,  $\overline{\text{CAS}}$  and  $\overline{\text{RAS}}$  must be pulsed for tcp.
- 10. Operation with the tRCD (MAX) limit ensures that tRAC (MAX) can be met. tRCD (MAX) is specified as a reference point only; if tRCD is greater than the specified tRCD (MAX) limit, access time is controlled exclusively by tCAC.
- 11. Operation within the trad (MAX) limit ensures that trad (MAX) can be met. trad (MAX) is specified as a reference point only; if trad is greater than the specified trad (MAX) limit, access time is controlled exclusively by taa.
- 12. Either trich or trich must be satisfied for a READ cycle.
- 13. toff (MAX) defines the time at which the output achieves the open circuit condition; it is not a reference to Voh or Vol.
- 14. twcs, trwb, tawb and tcwb are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If twcs ≥ twcs (MIN), the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If trwb ≥ trwb (MIN), tawb ≥ tawb (MIN) and tcwb ≥ tcwb (MIN), the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until CAS and RAS or OE go back to Vih) is indeterminate. OE held HIGH and WE taken LOW after CAS goes LOW result in a LATE WRITE (OE-controlled) cycle.
- 15. Output parameter (I/O) is referenced to corresponding CAS input, I/O0-I/O7 by LCAS and I/O8-I/O15 by UCAS.
- 16. During a READ cycle, if  $\overline{OE}$  is LOW then taken HIGH before  $\overline{CAS}$  goes HIGH, I/O goes open. If  $\overline{OE}$  is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
- 17. Write command is defined as  $\overline{WE}$  going low.
- 18. LATE WRITE and READ-MODIFY-WRITE cycles must have both too and toeн met (OE HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if CAS remains LOW and OE is taken back to LOW after toeн is met.
- 19. The I/Os are in open during READ cycles once top or toff occur.
- 20. The first  $\chi \overline{CAS}$  edge to transition LOW.
- 21. The last  $\chi \overline{CAS}$  edge to transition HIGH.
- 22. These parameters are referenced to  $\overline{\text{CAS}}$  leading edge in EARLY WRITE cycles and  $\overline{\text{WE}}$  leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
- 23. Last falling  $\chi \overline{CAS}$  edge to first rising  $\chi \overline{CAS}$  edge.
- 24. Last rising  $\chi \overline{CAS}$  edge to next cycle's last rising  $\chi \overline{CAS}$  edge.
- 25. Last rising  $\chi \overline{CAS}$  edge to first falling  $\chi \overline{CAS}$  edge.
- 26. Each  $\chi \overline{CAS}$  must meet minimum pulse width.
- 27. Last  $\chi \overline{CAS}$  to go LOW.
- 28. I/Os controlled, regardless UCAS and LCAS.
- 29. The 3 ns minimum is a parameter guaranteed by design.
- 30. Enables on-chip refresh and address counters.



## **READ CYCLE**

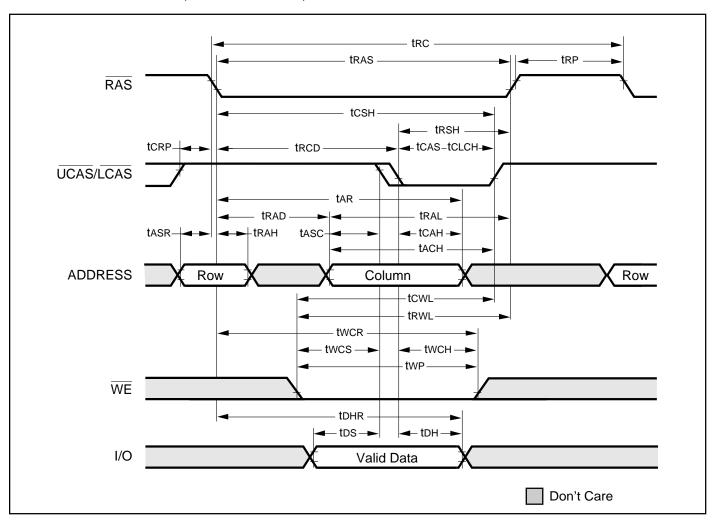


#### Note:

1. toff is referenced from rising edge of RAS or CAS, whichever occurs last.

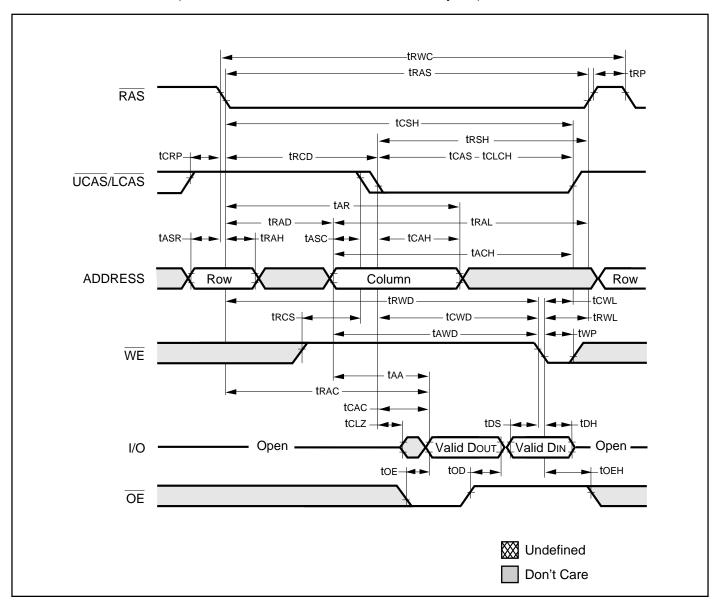


# **EARLY WRITE CYCLE** (OE = DON'T CARE)



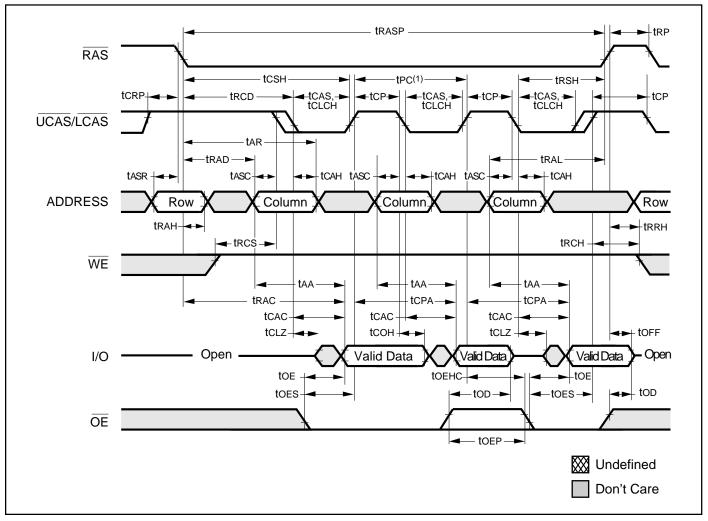


# READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)





### **EDO-PAGE-MODE READ CYCLE**

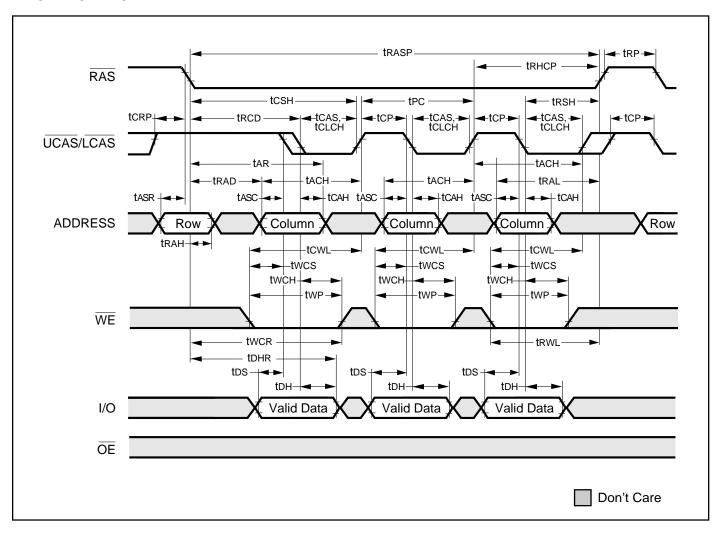


#### Note:

1. tPC can be measured from falling edge of  $\overline{CAS}$  to falling edge of  $\overline{CAS}$ , or from rising edge of  $\overline{CAS}$  to rising edge of  $\overline{CAS}$ . Both measurements must meet the tPC specifications.

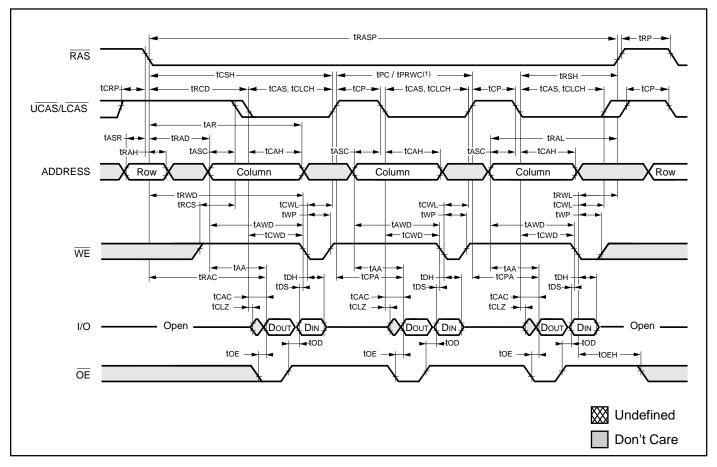


# **EDO-PAGE-MODE EARLY-WRITE CYCLE**





# EDO-PAGE-MODE READ-WRITE CYCLE (LATE WRITE and READ-MODIFY WRITE Cycles)

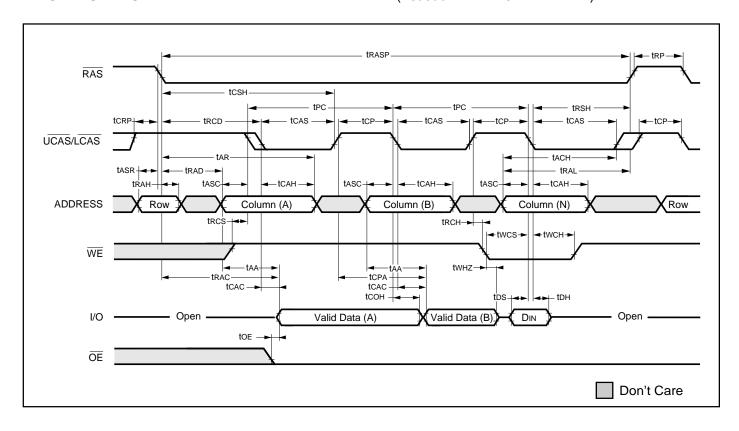


#### Note:

1. the can be measured from falling edge of  $\overline{CAS}$  to falling edge of  $\overline{CAS}$ , or from rising edge of  $\overline{CAS}$  to rising edge of  $\overline{CAS}$ . Both measurements must meet the the specifications.



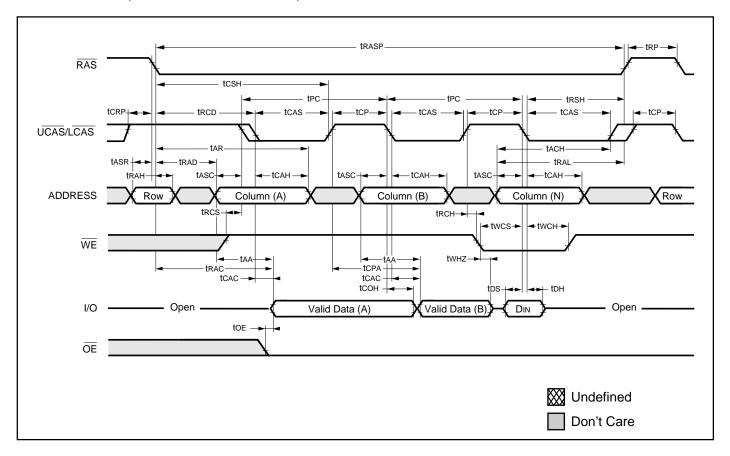
# EDO-PAGE-MODE READ-EARLY-WRITE CYCLE (Psuedo READ-MODIFY WRITE)



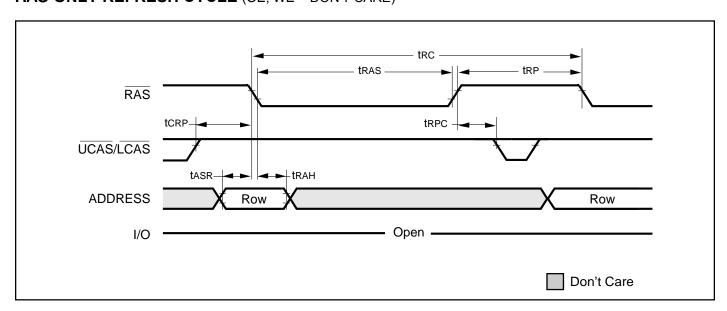


### **AC WAVEFORMS**

# READ CYCLE (With WE-Controlled Disable)

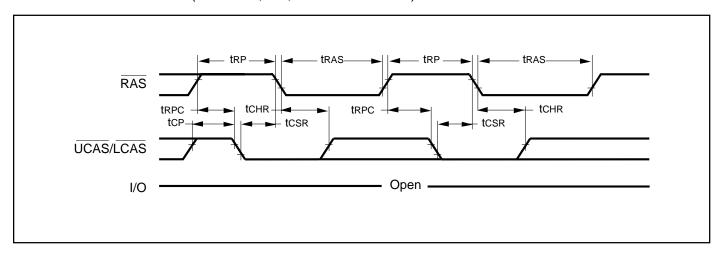


# RAS-ONLY REFRESH CYCLE (OE, WE = DON'T CARE)

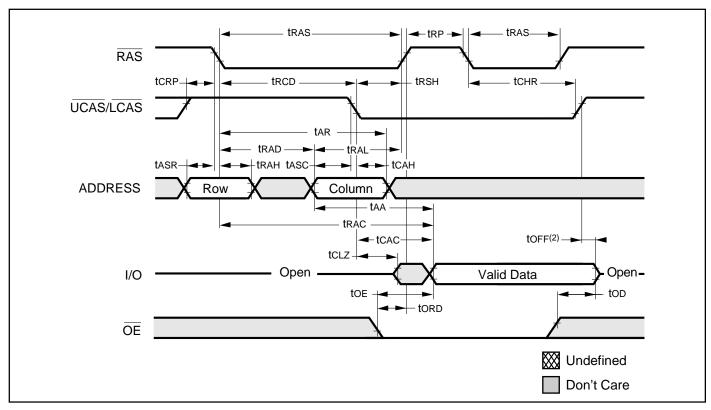




# **CBR REFRESH CYCLE** (Addresses; WE, OE = DON'T CARE)



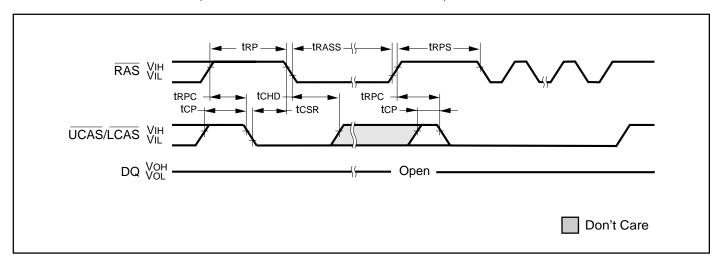
# HIDDEN REFRESH CYCLE(1) (WE = HIGH; OE = LOW)



- 1. A Hidden Refresh may also be performed after a Write Cycle. In this case,  $\overline{WE}$  = LOW and  $\overline{OE}$  = HIGH. 2. toff is referenced from rising edge of  $\overline{RAS}$  or  $\overline{CAS}$ , whichever occurs last.



# **SELF REFRESH CYCLE** (Addresses : $\overline{WE}$ and $\overline{OE}$ = DON'T CARE)



## **TIMING PARAMETERS**

|              | -4   | 15   |      | 50   | -6   | 60   |       |  |
|--------------|------|------|------|------|------|------|-------|--|
| Symbol       | Min. | Max. | Min. | Max. | Min. | Max. | Units |  |
| <b>t</b> CHD | 8    | _    | 8    | _    | 10   | _    | ns    |  |
| tcp          | 7    | _    | 9    | _    | 9    | _    | ns    |  |
| tcsr         | 5    | _    | 5    | _    | 5    | _    | ns    |  |
| trass        | 100  | _    | 100  | _    | 100  | _    | μs    |  |
| trp          | 28   | _    | 30   | _    | 40   | _    | ns    |  |
| trps         | 77   | _    | 84   | _    | 104  | _    | ns    |  |
| <b>t</b> RPC | 5    | _    | 5    | _    | 5    | _    | ns    |  |

# **ORDERING INFORMATION: 5V (Pb-free)**

Commercial Range: 0°C to 70°C

| Speed (ns) | Order Part No.     | Package                |
|------------|--------------------|------------------------|
| 45         | IC41C16100S-45K(G) | 400mil SOJ(Pb-free)    |
|            | IC41C16100S-45T(G) | 400mil TSOP-2(Pb-free) |
| 50         | IC41C16100S-50K(G) | 400mil SOJ(Pb-free)    |
|            | IC41C16100S-50T(G) | 400mil TSOP-2(Pb-free) |
| 60         | IC41C16100S-60K(G) | 400mil SOJ(Pb-free)    |
|            | IC41C16100S-60T(G) | 400mil TSOP-2(Pb-free) |

# **ORDERING INFORMATION: 5V (Pb-free)**

Industrial Range: -40°C to 85°C

| Speed (ns) | Order Part No.                             | Package                                       |
|------------|--|---|
| 45         | IC41C16100S-45KI(G)<br>IC41C16100S-45TI(G) | 400mil SOJ(Pb-free)<br>400mil TSOP-2(Pb-free) |
| 50         | IC41C16100S-50KI(G)<br>IC41C16100S-50TI(G) | 400mil SOJ(Pb-free)<br>400mil TSOP-2(Pb-free) |
| 60         | IC41C16100S-60KI(G)<br>IC41C16100S-60TI(G) | 400mil SOJ(Pb-free)<br>400mil TSOP-2(Pb-free) |



# **ORDERING INFORMATION: 3.3V (Pb-free)**

Commercial Range: 0°C to 70°C

| Speed (ns) | Order Part No.      | Package                |
|------------|---------------------|------------------------|
| 45         | IC41LV16100S-45K(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-45T(G) | 400mil TSOP-2(Pb-free) |
| 50         | IC41LV16100S-50K(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-50T(G) | 400mil TSOP-2(Pb-free) |
| 60         | IC41LV16100S-60K(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-60T(G) | 400mil TSOP-2(Pb-free) |

## **ORDERING INFORMATION: 3.3V (Pb-free)**

Industrial Range: -40°C to 85°C

| Speed (ns) | Order Part No.       | Package                |
|------------|----------------------|------------------------|
| 45         | IC41LV16100S-45KI(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-45TI(G) | 400mil TSOP-2(Pb-free) |
| 50         | IC41LV16100S-50KI(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-50TI(G) | 400mil TSOP-2(Pb-free) |
| 60         | IC41LV16100S-60KI(G) | 400mil SOJ(Pb-free)    |
|            | IC41LV16100S-60TI(G) | 400mil TSOP-2(Pb-free) |



# Integrated Circuit Solution Inc.

**HEADQUARTER:** 

NO.2, TECHNOLOGY RD. V, SCIENCE-BASED INDUSTRIAL PARK,

HSIN-CHU, TAIWAN, R.O.C.

TEL: 886-3-5780333 Fax: 886-3-5783000

**BRANCH OFFICE:** 

7F, NO. 106, SEC. 1, HSIN-TAI 5<sup>TH</sup> ROAD, HSICHIH TAIPEI COUNTY, TAIWAN, R.O.C.

TEL: 886-2-26962140

FAX: 886-2-26962252

http://www.icsi.com.tw